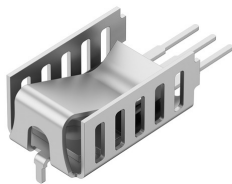




Data sheet Product FK 259 MI 220 H



- Board Level heatsinks>Attachable heatsink
- universal clip-on heatsinks for design TO 220 and similar
 - integrated clamp geometry for a secure fixing of the device
 - angled designs with enlarged surface
 - modifications and special designs according to customer's specifications

Features

material:	copper (Cu)
for transistor:	<ul style="list-style-type: none">• TO 220• TO 248• SIP-Multiwatt• TO 247• TO 218
width:	13 mm
height:	9 mm
length:	21 mm
thermal resistance:	24.7 K/W
surface:	solderable surface
version:	with solder lug for horizontal installation
material thickness:	0.6 mm

Technical Drawing

24,7 K/W

